

8 COMMERCIAL ROAD READING, BERKSHIRE, RG2 0QZ, UK T: +44 (0) 118 918 2400 F: +44 (0) 118 986 7331

www.solderpaste.co.uk

# NO CLEAN SOLDER PASTE

NC-3701-GE

## **GE Flux Has Been Independently Tested To Meet The Bellcore Specification**

ESL NC-3701-GE is a no-clean RMA solder paste. The paste can be screen printed up to speeds of 200 mm / sec and reflowed according to ESL's standard solder paste processing procedures. Reflowing results in shiny solder joints with a small amount of hard, clear, benign residue that requires no removal. The rheology is suitable for fine pitch applications. The screened paste exhibits excellent tack properties and anti-slump characteristics. Before use, gentle stirring with a spatula is recommended for 15 seconds.

### **PASTE DATA**

**Solder Alloy:** 

(Meets QQ-S-571-E specifications) 62%Sn / 36%Pb / 2%Ag

Particle Size: -325 / +500 mesh
Rheology: Screen-printable paste

Viscosity:

(TF spindle, 5 rpm,  $25.5 \pm 0.5$  °C) 775  $\pm 25$  Pa.s Solids: 90  $\pm 0.5$  %

Shelf Life:

(3 - 20°C, may be refrigerated) 6 months

Flux: Rosin mildly activated

#### **TECHNICAL DATA**

Test Specification Result

Silver Chromate Paper Test: Bellcore TR-NWT-000078 No colour change

(Test For Halides) IPC-TM-650

Copper Mirror Test: Bellcore TR-NVVT-000078 Type L

IPC-TM-650

(no breakthrough)

**Surface Insulation Resistance:** TR-NWT-000078 1.39 x 10<sup>12</sup> (after 96 hrs)

35°C/85% R.H

Visual examination - no evidence of Blue-Green corrosion and dendritic growth was observed on patterns

**Electro-migration:** Bellcore TR-NWT-000078 85°C/85% R.H 2.10 x 10<sup>10</sup>

(after 500 hrs)

Visual examination - no evidence of electro-migration on test samples

ESL Europe NC-3701-GE 0603-I

FSI Worldwide

ESL ElectroScience (USA) • 416 East Church Road • King of Prussia • PA 19406-2625 • U.S.A • Tel: +1 610-272-8000 • Fax: +1 610-272-6759 • Sales@ElectroScience.com

ESL Nippon • Sukegawa Bldg. 6th floor, 3-4 Yanagibashi 1-chome, Taito-ku, Tokyo 111, Japan • Tel: +81-3-3864-8521 • Fax: +81-3-3864-9270 • Sales@ESL-Nippon.co.jp

ESL China • Room #2712, Far East International Plaza, No.317 Xianxia Road, Changning District, Shanghai, China 200051 • Tel: +86-21-6237-0336 • Fax: +86-21-6237-0338 • ESLChina@eslshanghai.net

## **TYPICAL PROPERTIES**

 $(175 \pm 25 \mu m \text{ wet print thickness})$ 

**Approximate Coverage:** 12.5 cm<sup>2</sup> / g

**Printing Resolution:** 

(line / space) 0.400 mm / 0.400 mm

Screen time: > 8 hours

Tack Time: > 30 hours

**Packaging:** 500 - 1000 grams in jars 500 - 1000 grams in cartridges

PROCESSING:

**Screen Mesh, Emulsion:** 80 S/S, 150 - 200 μm

Stencil Material, Thickness: laser cut, nickel formed, etched S/S, 150 - 200 µm

**Reflow Temperature:** Standard reflow profiles used for RMA pastes are appropriate.

This paste is designed to be reflowed in air, but it may also be

reflowed in N<sub>2</sub>.

Flux Removal: Not required. Note: If cleaning is desired; residue can be

removed using standard flux solvent or saponifier cleaning

methods.

Thinner: ESL 401

ESL Europe NC-3701-GE 0603-I

**CAUTION:** Proper industrial safety precautions should be exercised in using these products. Use with adequate ventilation. Avoid prolonged contact with skin or inhalation of any vapours emitted during use or heating of these compositions. The use of safety eye goggles, gloves or hand protection creams is recommended. Wash hands or skin thoroughly with soap and water after using these products. Do not eat or smoke in areas where these materials are used. Refer to appropriate MSDS sheet.